IS61C64AH

8K x 8 HIGH-SPEED CMOS STATIC RAM

MAY 1999

ISSI®

FEATURES

- High-speed access time: 15, 20, 25 ns
- Automatic power-down when chip is deselected
- CMOS low power operation
  — 450 mW (typical) operating
  — 250 μW (typical) standby
- TTL compatible interface levels
- Single 5V power supply
- Fully static operation: no clock or refresh required
- Three state outputs
- Two Chip Enables ($\overline{CE1}$ and CE2) for simple memory expansion
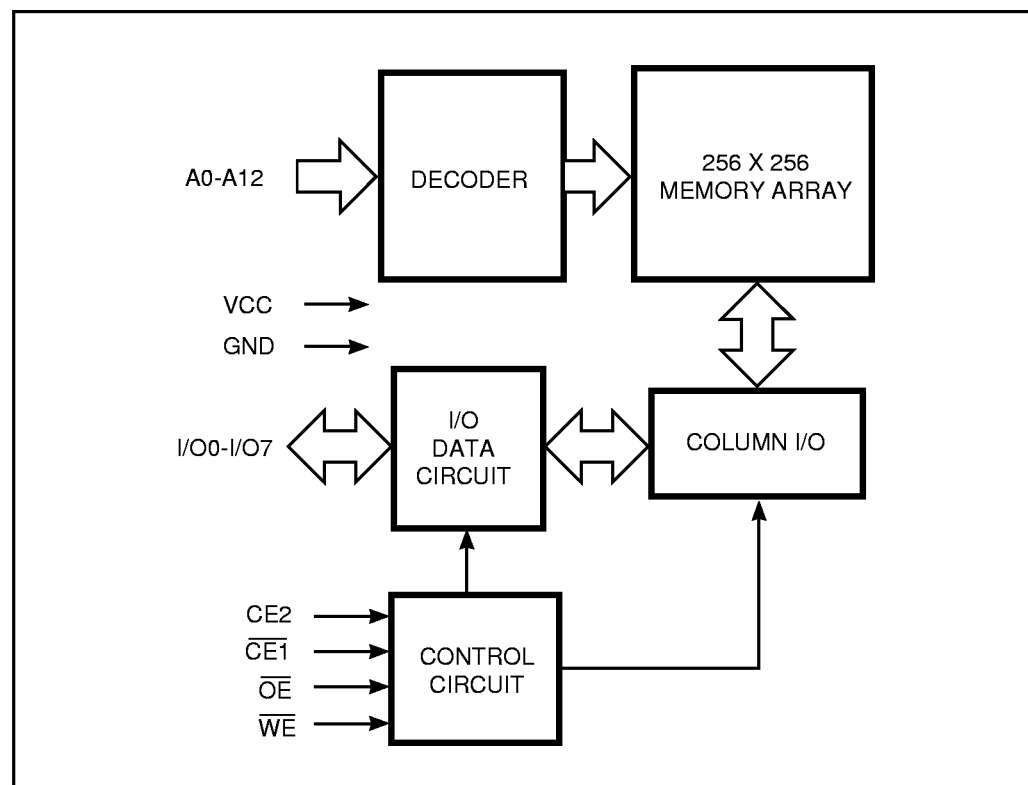
DESCRIPTION

The *ISSI* IS61C64AH is a very high-speed, low power, 8192-word by 8-bit static RAM. It is fabricated using *ISSI*'s high-performance CMOS technology. This highly reliable process coupled with innovative circuit design techniques, yields access times as fast as 15 ns with low power consumption.

When $\overline{CE1}$ is HIGH or CE2 is LOW (deselected), the device assumes a standby mode at which the power dissipation can be reduced down to 250 μW (typical) with CMOS input levels.

Easy memory expansion is provided by using two Chip Enable inputs, $\overline{CE1}$ and CE2. The active LOW Write Enable ($\overline{WE}$) controls both writing and reading of the memory.

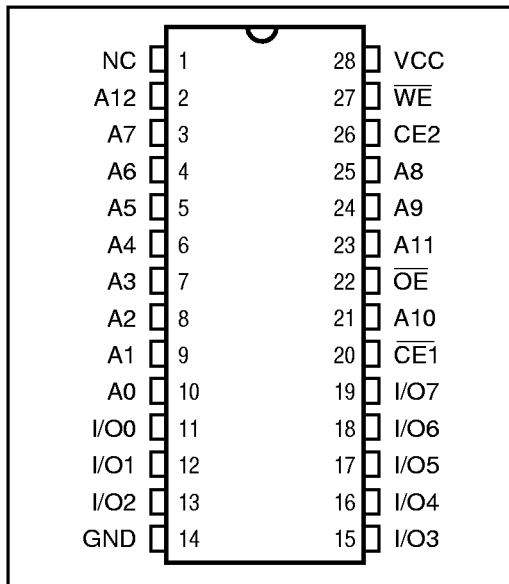The IS61C64AH is packaged in the JEDEC standard 28-pin, SOJ and 330-mil SOP.

FUNCTIONAL BLOCK DIAGRAM

PIN CONFIGURATION
28-Pin SOJ and SOP

```
NC     [ 1      28 ]  VCC
A12    [ 2      27 ]  WE
A7     [ 3      26 ]  CE2
A6     [ 4      25 ]  A8
A5     [ 5      24 ]  A9
A4     [ 6      23 ]  A11
A3     [ 7      22 ]  OE
A2     [ 8      21 ]  A10
A1     [ 9      20 ]  CE1
A0     [ 10     19 ]  I/O7
I/O0   [ 11     18 ]  I/O6
I/O1   [ 12     17 ]  I/O5
I/O2   [ 13     16 ]  I/O4
GND    [ 14     15 ]  I/O3
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PIN DESCRIPTIONS

A0-A12	Address Inputs
$\overline{CE1}$	Chip Enable 1 Input
CE2	Chip Enable 2 Input
$\overline{OE}$	Output Enable Input
$\overline{WE}$	Write Enable Input
I/O0-I/O7	Input/Output
Vcc	Power
GND	Ground

TRUTH TABLE

Mode	$\overline{WE}$	$\overline{CE1}$	CE2	$\overline{OE}$	I/O Operation	Vcc Current
Not Selected	X	H	X	X	High-Z	I_{SB1}, I_{SB2}
(Power-down)	X	X	L	X	High-Z	I_{SB1}, I_{SB2}
Output Disabled	H	L	H	H	High-Z	I_{CC}
Read	H	L	H	L	D_{OUT}	I_{CC}
Write	L	L	H	X	D_{IN}	I_{CC}

ABSOLUTE MAXIMUM RATINGS[1]

Symbol	Parameter	Value	Unit
V_{TERM}	Terminal Voltage with Respect to GND	−0.5 to +7.0	V
T_{BIAS}	Temperature Under Bias	−55 to +125	°C
T_{STG}	Storage Temperature	−65 to +150	°C
P_T	Power Dissipation	1.0	W
I_{OUT}	DC Output Current (LOW)	20	mA

Notes:
1. Stress greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

OPERATING RANGE

Range	Ambient Temperature	Vcc
Commercial	0°C to +70°C	5V ± 10%
Industrial[1]	−40°C to +85°C	5V ± 10%

Notes:
1. Industrial supplement specification available upon request.

DC ELECTRICAL CHARACTERISTICS (Over Operating Range)

Symbol	Parameter	Test Conditions	Min.	Max.	Unit
V_{OH}	Output HIGH Voltage	V_{CC} = Min., I_{OH} = −4.0 mA	2.4	—	V
V_{OL}	Output LOW Voltage	V_{CC} = Min., I_{OL} = 8.0 mA	—	0.4	V
V_{IH}	Input HIGH Voltage		2.2	V_{CC} + 0.5	V
V_{IL}	Input LOW Voltage[1]		−0.5	0.8	V
I_{LI}	Input Leakage	GND ≤ V_{IN} ≤ V_{CC}	−2	2	μA
I_{LO}	Output Leakage	GND ≤ V_{OUT} ≤ V_{CC}, Outputs Disabled	−2	2	μA

Note:
1. V_{IL} = −3.0V for pulse width less than 10 ns.

POWER SUPPLY CHARACTERISTICS[1] (Over Operating Range)

Symbol	Parameter	Test Conditions	-15 ns Min.	-15 ns Max.	-20 ns Min.	-20 ns Max.	-25 ns Min.	-25 ns Max.	Unit
I_{CC}	V_{CC} Dynamic Operating Supply Current	V_{CC} = Max., I_{OUT} = 0 mA, f = f_{MAX}	—	135	—	120	—	110	mA
I_{SB1}	TTL Standby Current (TTL Inputs)	V_{CC} = Max., V_{IN} = V_{IH} or V_{IL} $\overline{CE1}$ ≥ V_{IH} or CE2 ≤ V_{IL}, f = 0	—	20	—	20	—	20	mA
I_{SB2}	CMOS Standby Current (CMOS Inputs)	V_{CC} = Max., $\overline{CE1}$ ≥ V_{CC} − 0.2V, CE2 ≤ 0.2V, V_{IN} ≥ V_{CC} − 0.2V, or V_{IN} ≤ 0.2V, f = 0	—	6	—	6	—	6	mA

Note:
1. At f = f_{MAX}, address and data inputs are cycling at the maximum frequency, f = 0 means no input lines change.

CAPACITANCE[1,2]

Symbol	Parameter	Conditions	Max.	Unit
C_{IN}	Input Capacitance	V_{IN} = 0V	5	pF
C_{OUT}	Output Capacitance	V_{OUT} = 0V	7	pF

Notes:
1. Tested initially and after any design or process changes that may affect these parameters.
2. Test conditions: T_A = 25°C, f = 1 MHz, V_{CC} = 5.0V.

READ CYCLE SWITCHING CHARACTERISTICS[1] (Over Operating Range)

Symbol	Parameter	-15 ns Min.	-15 ns Max.	-20 ns Min.	-20 ns Max.	-25 ns Min.	-25 ns Max.	Unit
t_{RC}	Read Cycle Time	15	—	20	—	25	—	ns
t_{AA}	Address Access Time	—	15	—	20	—	25	ns
t_{OHA}	Output Hold Time	3	—	3	—	3	—	ns
t_{ACE1}	$\overline{CE1}$ Access Time	—	15	—	20	—	25	ns
t_{ACE2}	CE2 Access Time	—	15	—	20	—	25	ns
t_{DOE}	$\overline{OE}$ Access Time	—	7	—	7	—	9	ns
t_{LZOE}[2]	$\overline{OE}$ to Low-Z Output	0	—	0	—	0	—	ns
t_{HZOE}[2]	$\overline{OE}$ to High-Z Output	—	6	—	7	—	9	ns
t_{LZCE1}[2]	$\overline{CE1}$ to Low-Z Output	3	—	3	—	3	—	ns
t_{LZCE2}[2]	CE2 to Low-Z Output	3	—	3	—	3	—	ns
t_{HZCE}[2]	$\overline{CE1}$ or CE2 to High-Z Output	—	8	—	10	—	12	ns
t_{PU}[3]	$\overline{CE1}$ or CE2 to Power-Up	0	—	0	—	0	—	ns
t_{PD}[3]	$\overline{CE1}$ or CE2 to Power-Down	—	15	—	20	—	20	ns

Notes:
1. Test conditions assume signal transition times of 5 ns or less, timing reference levels of 1.5V, input pulse levels of 0 to 3.0V and output loading specified in Figure 1.
2. Tested with the load in Figure 2. Transition is measured ±500 mV from steady-state voltage. Not 100% tested.
3. Not 100% tested.

AC TEST CONDITIONS

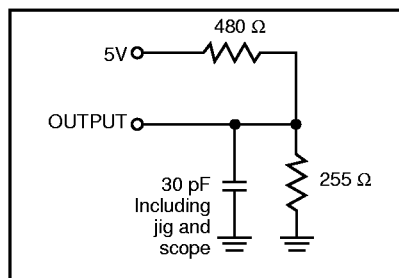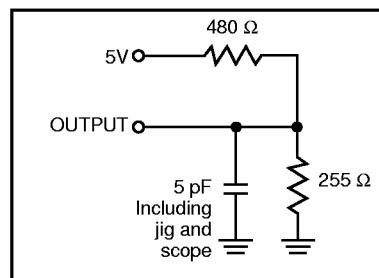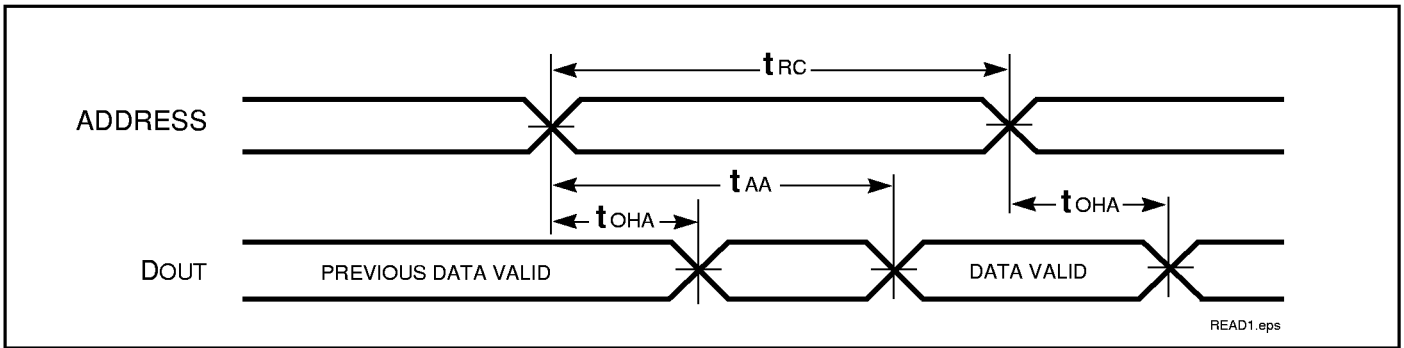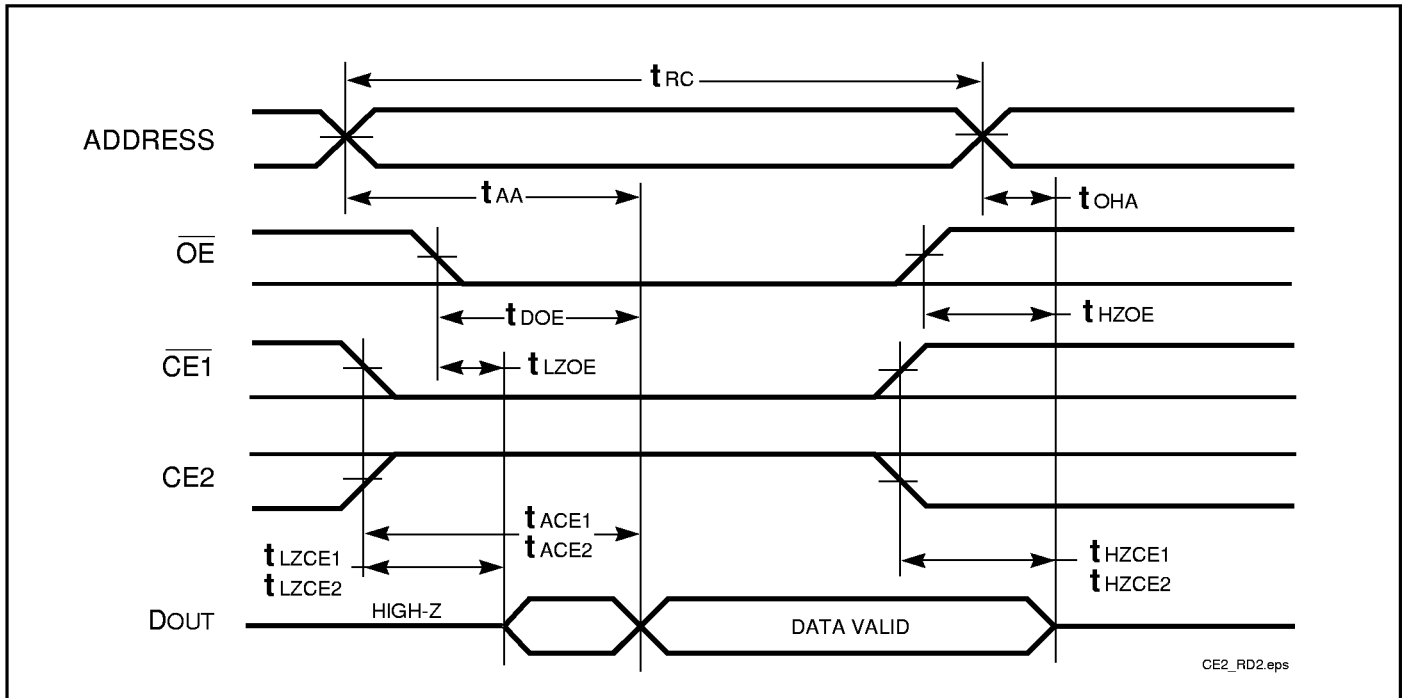| Parameter	Unit
Input Pulse Level	0V to 3.0V
Input Rise and Fall Times	3 ns
Input and Output Timing and Reference Level	1.5V
Output Load	See Figures 1 and 2

AC TEST LOADS

Figure 1.

Figure 2.

AC WAVEFORMS

READ CYCLE NO. 1[(1,2)]

READ1.eps

READ CYCLE NO. 2[(1,3)]

CE2_RD2.eps

Notes:
1. $\overline{WE}$ is HIGH for a Read Cycle.
2. The device is continuously selected. $\overline{OE}$, $\overline{CE1}$ = V_{IL}, CE2 = V_{IH}.
3. Address is valid prior to or coincident with $\overline{CE1}$ LOW and CE2 HIGH transitions.

WRITE CYCLE SWITCHING CHARACTERISTICS[1,3] (Over Operating Range)

Symbol	Parameter	-12 ns Min.	-12 ns Max.	-15 ns Min.	-15 ns Max.	-20 ns Min.	-20 ns Max.	-25 ns Min.	-25 ns Max.	Unit
t_{WC}	Write Cycle Time	12	—	15	—	20	—	25	—	ns
t_{SCE1}	$\overline{CE1}$ to Write End	10	—	12	—	17	—	22	—	ns
t_{SCE2}	CE2 to Write End	10	—	12	—	17	—	22	—	ns
t_{AW}	Address Setup Time to Write End	10	—	12	—	15	—	20	—	ns
t_{HA}	Address Hold from Write End	0	—	0	—	0	—	0	—	ns
t_{SA}	Address Setup Time	0	—	0	—	0	—	0	—	ns
t_{PWE}[4]	$\overline{WE}$ Pulse Width	8	—	10	—	12	—	15	—	ns
t_{SD}	Data Setup to Write End	8	—	9	—	10	—	12	—	ns
t_{HD}	Data Hold from Write End	0	—	0	—	0	—	0	—	ns
t_{HZWE}[2]	$\overline{WE}$ LOW to High-Z Output	—	6	—	8	—	10	—	12	ns
t_{LZWE}[2]	$\overline{WE}$ HIGH to Low-Z Output	0	—	0	—	0	—	0	—	ns

Notes:
1. Test conditions assume signal transition times of 5 ns or less, timing reference levels of 1.5V, input pulse levels of 0 to 3.0V and output loading specified in Figure 1.
2. Tested with the load in Figure 2. Transition is measured ±500 mV from steady-state voltage. Not 100% tested.
3. The internal write time is defined by the overlap of $\overline{CE1}$ LOW, CE2 HIGH and $\overline{WE}$ LOW. All signals must be in valid states to initiate a Write, but any one can go inactive to terminate the Write. The Data Input Setup and Hold timing are referenced to the rising or falling edge of the signal that terminates the write.
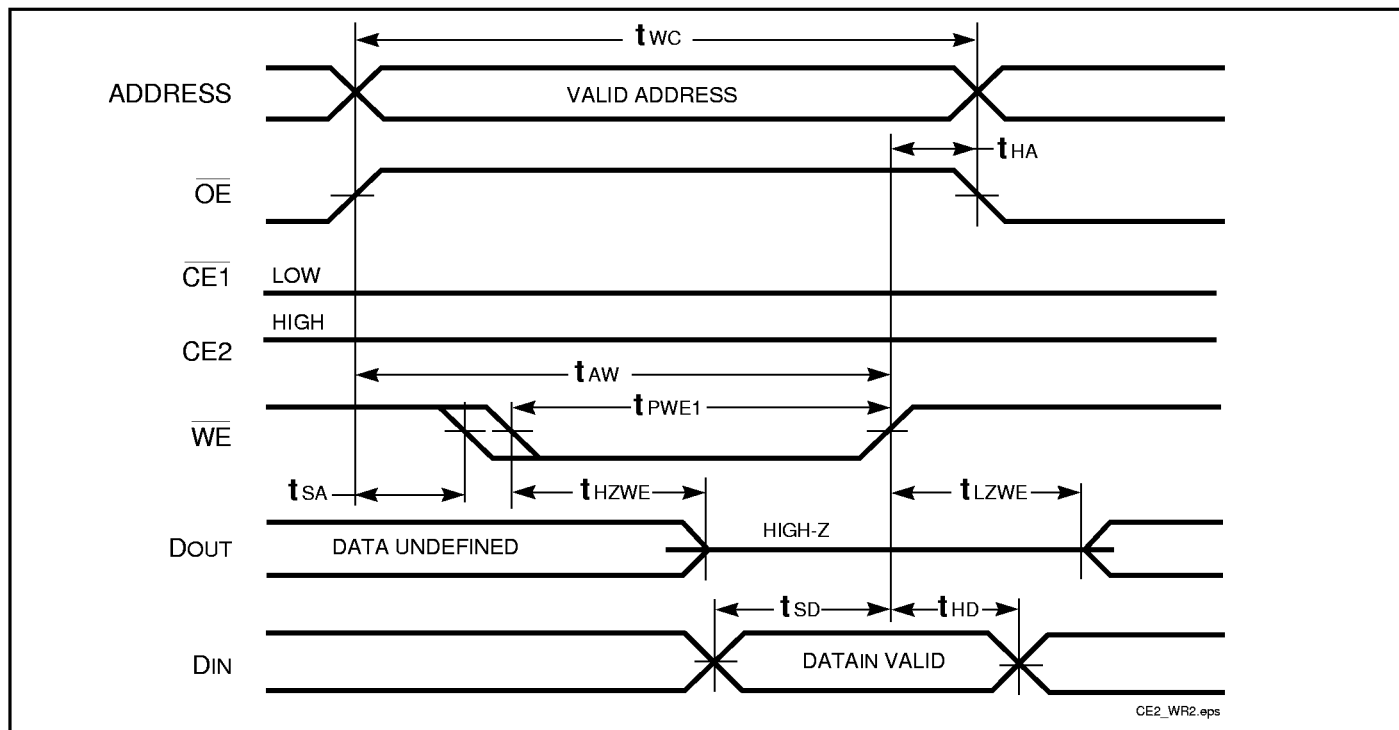
AC WAVEFORMS
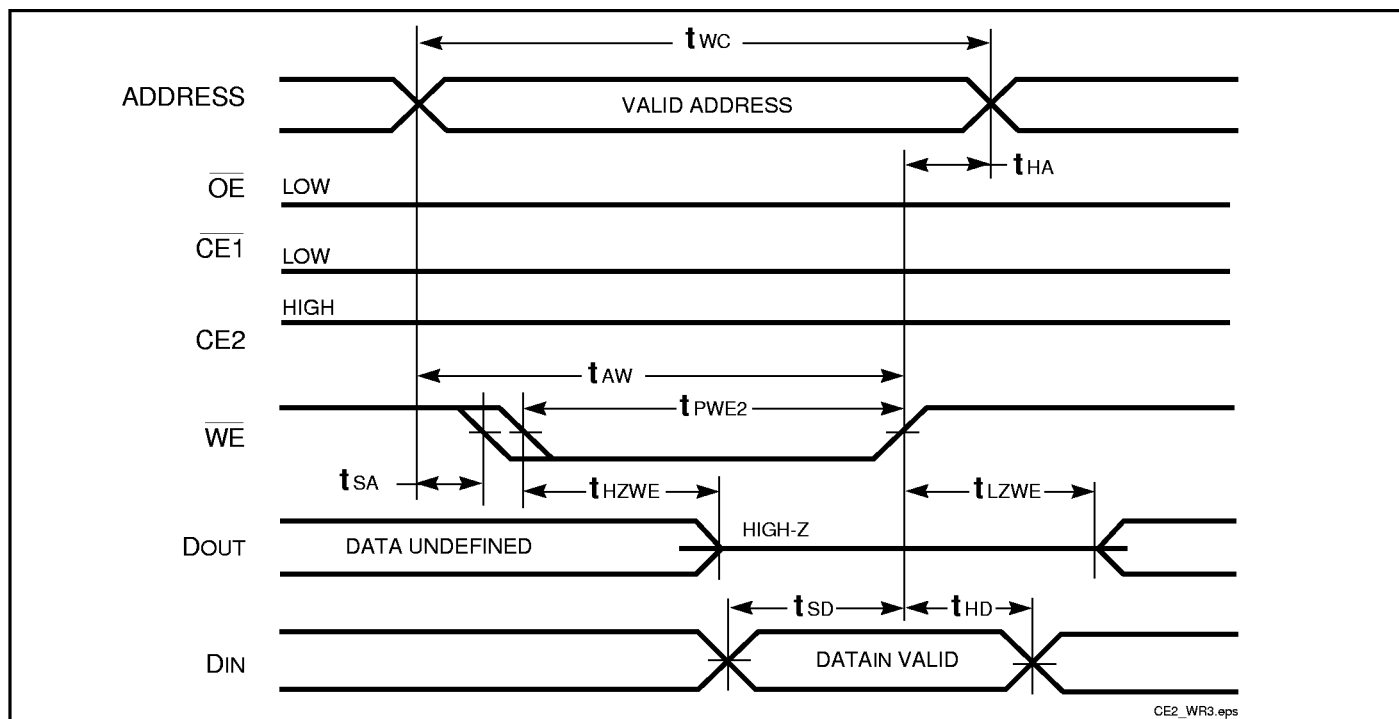## WRITE CYCLE NO. 1 ($\overline{CE}$ Controlled, $\overline{OE}$ is HIGH or LOW) [1]
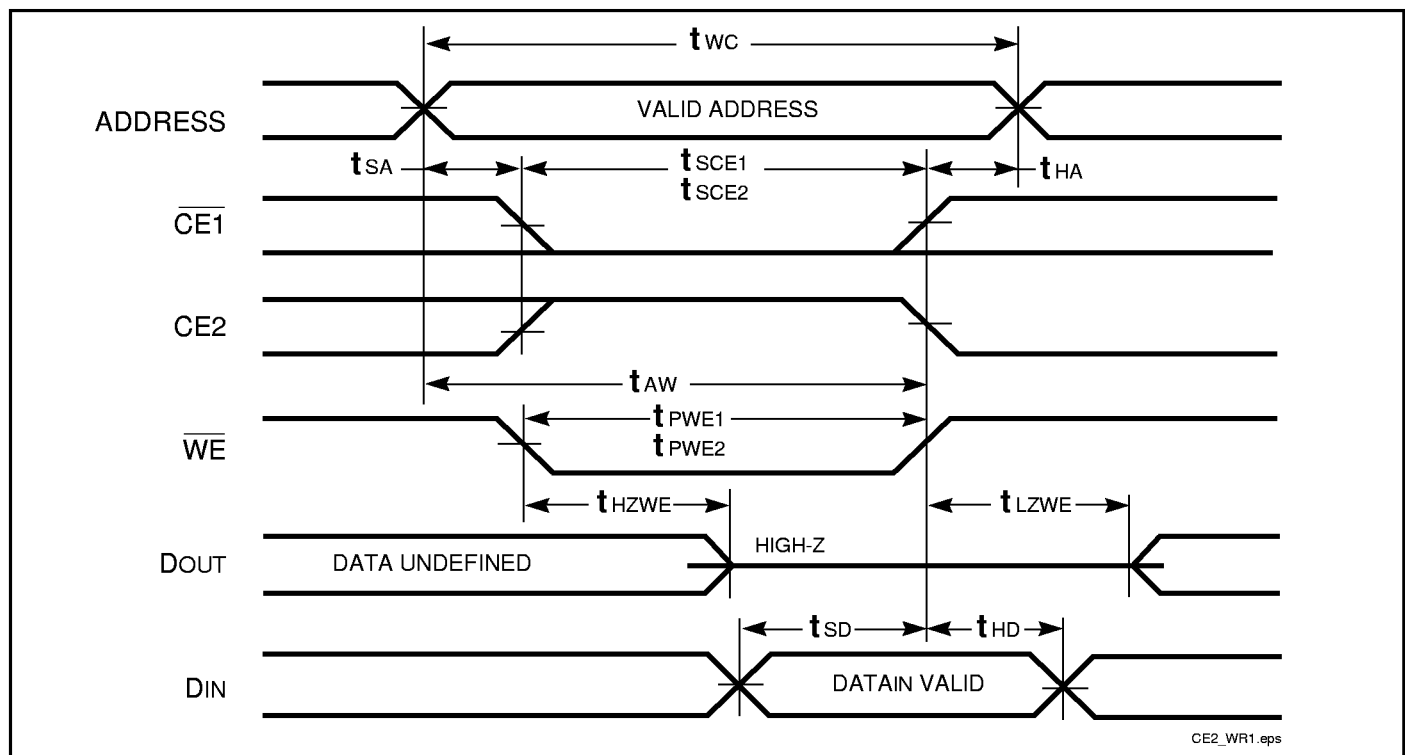
AC WAVEFORMS

WRITE CYCLE NO. 2 ($\overline{OE}$ is HIGH During Write Cycle) [1,2]

CE2_WR2.eps

WRITE CYCLE NO. 3 ($\overline{OE}$ is LOW During Write Cycle) [1]

CE2_WR3.eps

Notes:
1. The internal write time is defined by the overlap of $\overline{CE1}$ LOW, CE2 HIGH and $\overline{WE}$ LOW. All signals must be in valid states to initiate a Write, but any one can go inactive to terminate the Write. The Data Input Setup and Hold timing are referenced to the rising or falling edge of the signal that terminates the write.
2. I/O will assume the High-Z state if $\overline{OE} = V_{IH}$.

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ORDERING INFORMATION

Commercial Range: 0°C to +70°C

Speed (ns)	Order Part No.	Package
15	IS61C64AH-15J	300-mil Plastic SOJ
	IS61C64AH-15U	330-mil Plastic SOP
20	IS61C64AH-20J	300-mil Plastic SOJ
	IS61C64AH-20U	330-mil Plastic SOP
25	IS61C64AH-25J	300-mil Plastic SOJ
	IS61C64AH-25U	330-mil Plastic SOP

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